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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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GaAs INTEGRATED CIRCUIT $\mu PG2413T6M$

v

SP3T SWITCH FOR Bluetooth[™] AND 802.11b/g

DESCRIPTION

The μ PG2413T6M is a GaAs MMIC SP3T switch which was developed for Bluetooth, wireless LAN. This device can operate frequencies from 0.5 to 3.0 GHz, with low insertion loss.

This device is housed in a 12-pin plastic TSQFN (<u>Thin Small Quad Flat Non-leaded</u>) (T6M) package and is suitable for high-density surface mounting.

FEATURES

٠	Switch Control voltage	: Vcont (H) = 3.0 V TYP., Vcont (L) = 0 V TYP.
•	Low insertion loss	: Lins = 0.35 dB TYP. @ f = 1.0 GHz
		: Lins = 0.45 dB TYP. @ f = 2.0 GHz
		: Lins = 0.50 dB TYP. @ f = 2.5 GHz
٠	High isolation	: ISL = 26 dB TYP. @ f = 1.0 GHz
		: ISL = 20 dB TYP. @ f = 2.0 GHz
		: ISL = 18 dB TYP. @ f = 2.5 GHz
•	Handling power	: Pin (0.1 dB) = +28.0 dBm TYP. @ f = 2.5 GHz, V_{cont} (H) = 3.0 V, V_{cont} (L) = 0 V
•	High-density surface mounting	: 12-pin plastic TSQFN (T6M) package (2.0 $ imes$ 2.0 $ imes$ 0.37 mm)

APPLICATIONS

• Bluetooth and IEEE802.11b/g etc.

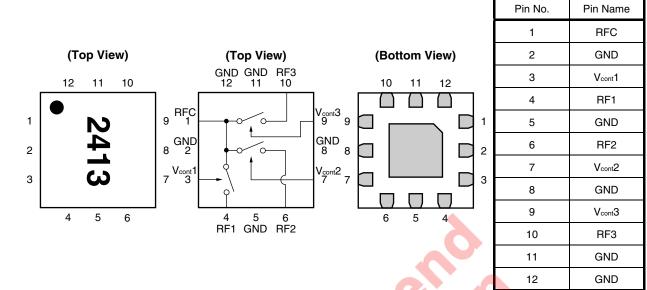
ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPG2413T6M-E2	μPG2413T6M-E2-A	12-pin plastic TSQFN (T6M) (Pb-Free)	2413	 Embossed tape 8 mm wide Pin 10, 11, 12 face the perforation side of the tape Qty 3 kpcs/reel

Remark To order evaluation samples, please contact your nearby sales office. Part number for sample order: μ PG2413T6M

Caution Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions must be employed at all times.

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PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM

Remark Exposed pad : GND

TRUTH TABLE

Vcont 1	V _{cont} 2	V _{cont} 3	RFC-RF1	RFC-RF2	RFC-RF3
High	Low	Low	ON	OFF	OFF
Low	High	Low	OFF	ON	OFF
Low	Low	High	OFF	OFF	ON



ABSOLUTE MAXIMUM RATINGS (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	Vcont	+6.0 ^{Note}	V
Input Power (V _{cont (H)} = 1.8 V)	Pin	+26	dBm
Input Power (V _{cont (H)} = 2.3 V)	Pin	+28	dBm
Input Power (V _{cont (H)} = 3.0 V)	Pin	+32	dBm
Input Power (V _{cont (H)} = 3.6 V)	Pin	+34	dBm
Operating Ambient Temperature	TA	–45 to +85	°C
Storage Temperature	Tstg	–55 to +150	°C

Note $|V_{\text{cont (H)}} - V_{\text{cont (L)}}| \le 6.0 \text{ V}$

RECOMMENDED OPERATING RANGE (TA = +25°C)

RECOMMENDED OPERATING RANGE (TA = +25 C)						
Parameter	Symbol	MIN.	TYP.	MAX.	Unit	
Operating Frequency	f	0.5	-	3.0	GHz	
Switch Control Voltage (H)	Vcont (H)	1.8	3.0	3.6	v	
Switch Control Voltage (L)	Vcont (L)	-0.2	0	0.2	V	
Control Voltage Difference (H)	⊿Vcont (H) Note1	-0.1	0	0.1	V	
Control Voltage Difference (L)	⊿Vcont (L) Note2	-0.1	0	0.1	v	

Notes 1. ΔV_{cont} (H) is a difference between the maximum and the minimum control voltages among V_{cont}1 (H), V_{cont}2 (H) and V_{cont}3 (H).

2. ∠V_{cont (L)} is a difference between the maximum and the minimum control voltages among V_{cont1 (L)}, V_{cont2 (L)} and V_{cont3 (L)}.

ELECTRICAL CHARACTERISTICS 1

(TA = +25°C, V_{cont} (H) = 3.0 V, V_{cont} (L) = 0 V, Z₀ = 50 Ω , DC blocking capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Pass	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss	Lins	RFC to RF1, 2, 3	f = 0.5 to 1.0 GHz	-	0.35	0.60	dB
			f = 1.0 to 2.0 GHz	-	0.45	0.70	dB
			f = 2.0 to 2.5 GHz	-	0.50	0.75	dB
			f = 2.5 to 3.0 GHz	-	0.60	-	dB
Isolation	ISL	RFC to RF1, 2, 3	f = 0.5 to 1.0 GHz	23	26	_	dB
		(OFF)	f = 1.0 to 2.0 GHz	17	20	_	dB
			f = 2.0 to 2.5 GHz	15	18	_	dB
			f = 2.5 to 3.0 GHz	-	16	_	dB
Return Loss (RFC)	RLc		f = 0.5 to 3.0 GHz	15	20	_	dB
Return Loss (RF1, 2, 3)	RL1, 2, 3		f = 0.5 to 3.0 GHz	15	20	_	dB
0.1 dB Loss Compression Input Power ^{Note 1}	Pin (0.1 dB)	RFC to RF1, 2, 3	f = 2.5 GHz	+25.0	+28.0	-	dBm
1 dB Loss Compression Input Power ^{Note 2}	Pin (1 dB)	RFC to RF1, 2, 3	f = 2.5 GHz, V _{cont (H)} = 2.3 V	9	+27.0	-	dBm
			f = 2.5 GHz, V _{cont (H)} = 3.0 V	-	+31.0	-	dBm
		G	f = 2.5 GHz, V _{cont (H)} = 3.6 V	-	+33.0	-	dBm
2nd Harmonics	2f0		f = 2.5 GHz, P _{in} = 23 dBm	-	75	-	dBc
3rd Harmonics	3f0		f = 2.5 GHz, P _{in} = 23 dBm	_	75	-	dBc
Switch Control Current	Icont		No RF input	-	0.1	5.0	μA
Switch Control Speed	tsw		50% CTL to 90/10% RF	-	50	-	ns

Notes 1. Pin (0.1 dB) is the measured input power level when the insertion loss increases 0.1 dB more than that of the linear range.

2. P_{in (1 dB)} is the measured input power level when the insertion loss increases 1 dB more than that of the linear range.

Caution It is necessary to use DC blocking capacitors with this device.

ELECTRICAL CHARACTERISTICS 2

(TA = +25°C, V_{cont} (H) = 1.8 V, V_{cont} (L) = 0 V, Z₀ = 50 Ω , DC blocking capacitors = 56 pF, unless otherwise specified)

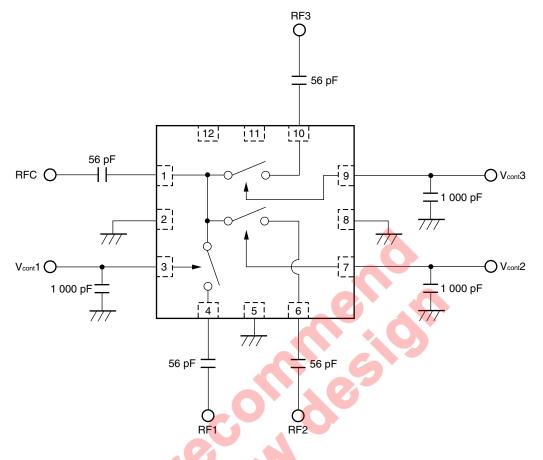
Parameter	Symbol	Pass	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss	Lins	RFC to RF1, 2, 3	f = 0.5 to 1.0 GHz	_	0.35	0.65	dB
			f = 1.0 to 2.0 GHz	I	0.45	0.75	dB
			f = 2.0 to 2.5 GHz	Ι	0.50	0.80	dB
			f = 2.5 to 3.0 GHz	-	0.65	-	dB
Isolation	ISL	RFC to RF1, 2, 3	f = 0.5 to 1.0 GHz	22.5	25.5	-	dB
		(OFF)	f = 1.0 to 2.0 GHz	16.5	19.5	-	dB
			f = 2.0 to 2.5 GHz	14.5	17.5	-	dB
			f = 2.5 to 3.0 GHz	-	15.5	-	dB
Return Loss (RFC)	RLc		f = 0.5 to 3.0 GHz	15	20	-	dB
Return Loss (RF1, 2, 3)	RL1, 2, 3		f = 0.5 to 3.0 GHz	15	20	-	dB
0.1 dB Loss Compression Input Power ^{Note 1}	Pin (0.1 dB)	RFC to RF1, 2, 3	f = 2.5 GHz	+19.0	+22.0	-	dBm
1 dB Loss Compression Input Power ^{Note 2}	Pin (1 dB)	RFC to RF1, 2, 3	f = 2.5 GHz	+21.0	+25.0	-	dBm
2nd Harmonics	2f0		f = 2.5 GHz, P _{in} = 17 dBm	-	75	-	dBc
3rd Harmonics	3f0	S A	f <mark>= 2.5</mark> GHz, P _{in} = 17 dBm	-	75	-	dBc
Switch Control Current	Icont		No RF input	-	0.1	5.0	μA
Switch Control Speed	tsw	S	50% CTL to 90/10% RF	-	50	_	ns

Notes 1. Pin (0.1 dB) is the measured input power level when the insertion loss increases 0.1 dB more than that of the linear range.

2. Pin (1 dB) is the measured input power level when the insertion loss increases 1 dB more than that of the linear range.

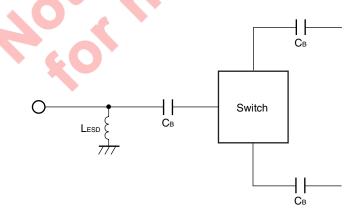
Caution It is necessary to use DC blocking capacitors with this device.

EVALUATION CIRCUIT



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

APPLICATION INFORMATION



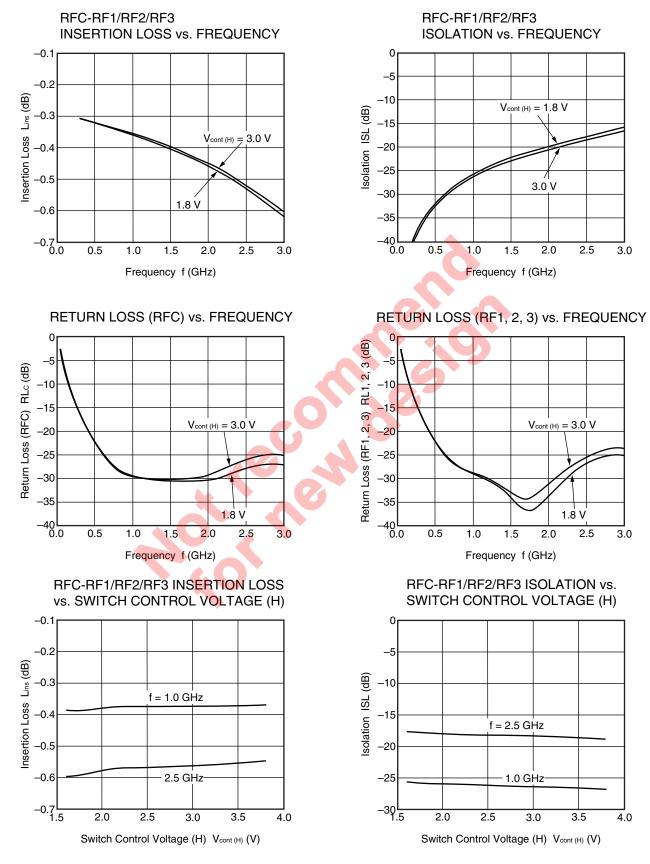
 \bullet C $_{B}$ are DC blocking capacitors external to the device.

A value of 56 pF is sufficient for operation from 500 MHz to 2.5 GHz bands.

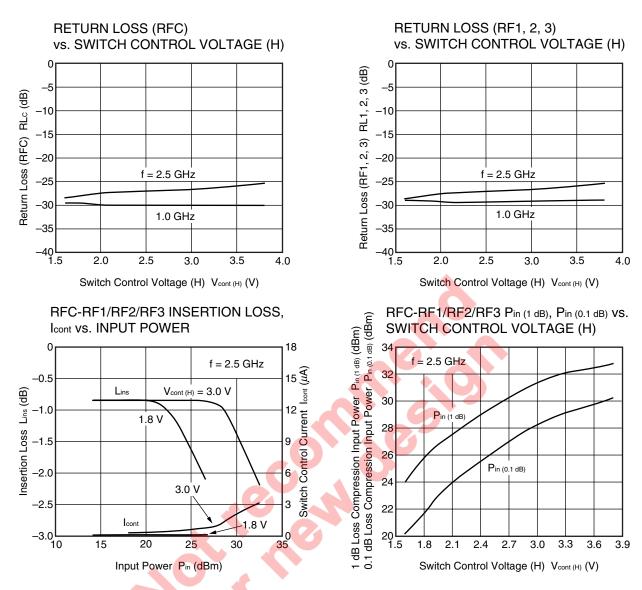
The value may be tailored to provide specific electrical responses.

- The RF ground connections should be kept as short as possible and connected to directly to a good RF ground for best performance.
- LESD provides a means to increase the ESD protection on a specific RF port, typically the port attached to the antenna.





Remark The graphs indicate nominal characteristics.

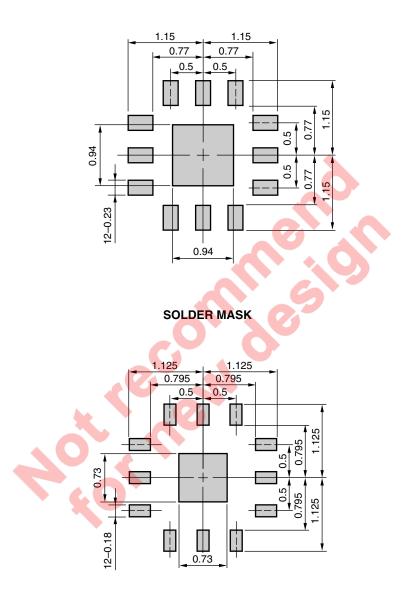


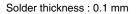
Remark The graphs indicate nominal characteristics.

MOUNTING PAD AND SOLDER MASK LAYOUT DIMENSIONS

12-PIN PLASTIC TSQFN (T6M) (UNIT: mm)

MOUNTING PAD

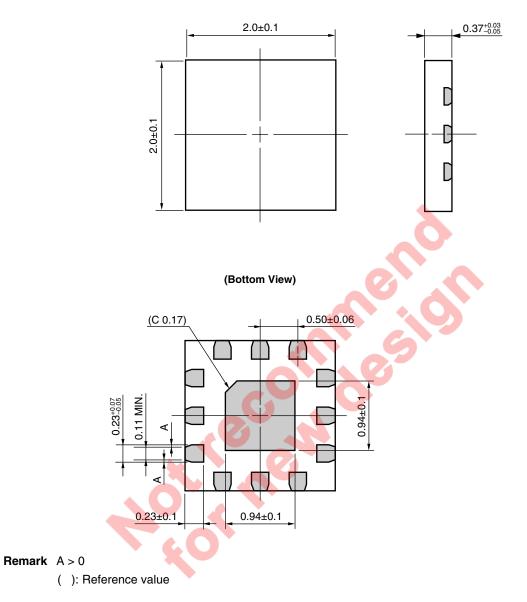




RemarkThe mounting pad and solder mask layouts in this document are for reference only.When designing PCB, please consider workability of mounting, solder joint reliability, prevention of solder
bridge and so on, in order to optimize the design.

PACKAGE DIMENSIONS

12-PIN PLASTIC TSQFN (T6M) (UNIT: mm)



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol	
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

Data Sheet PG10792EJ01V0DS

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	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
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